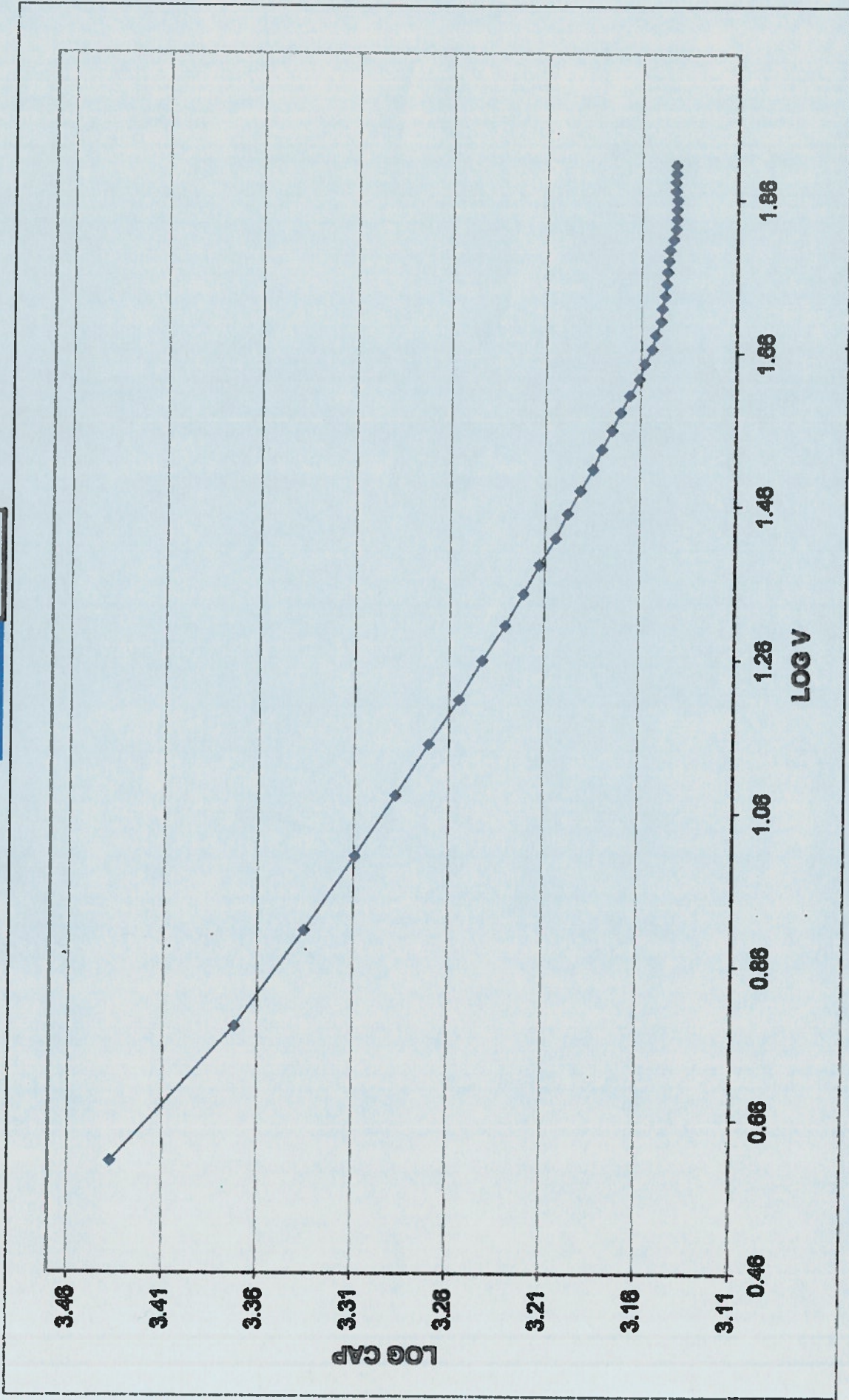


# Depletion Plot

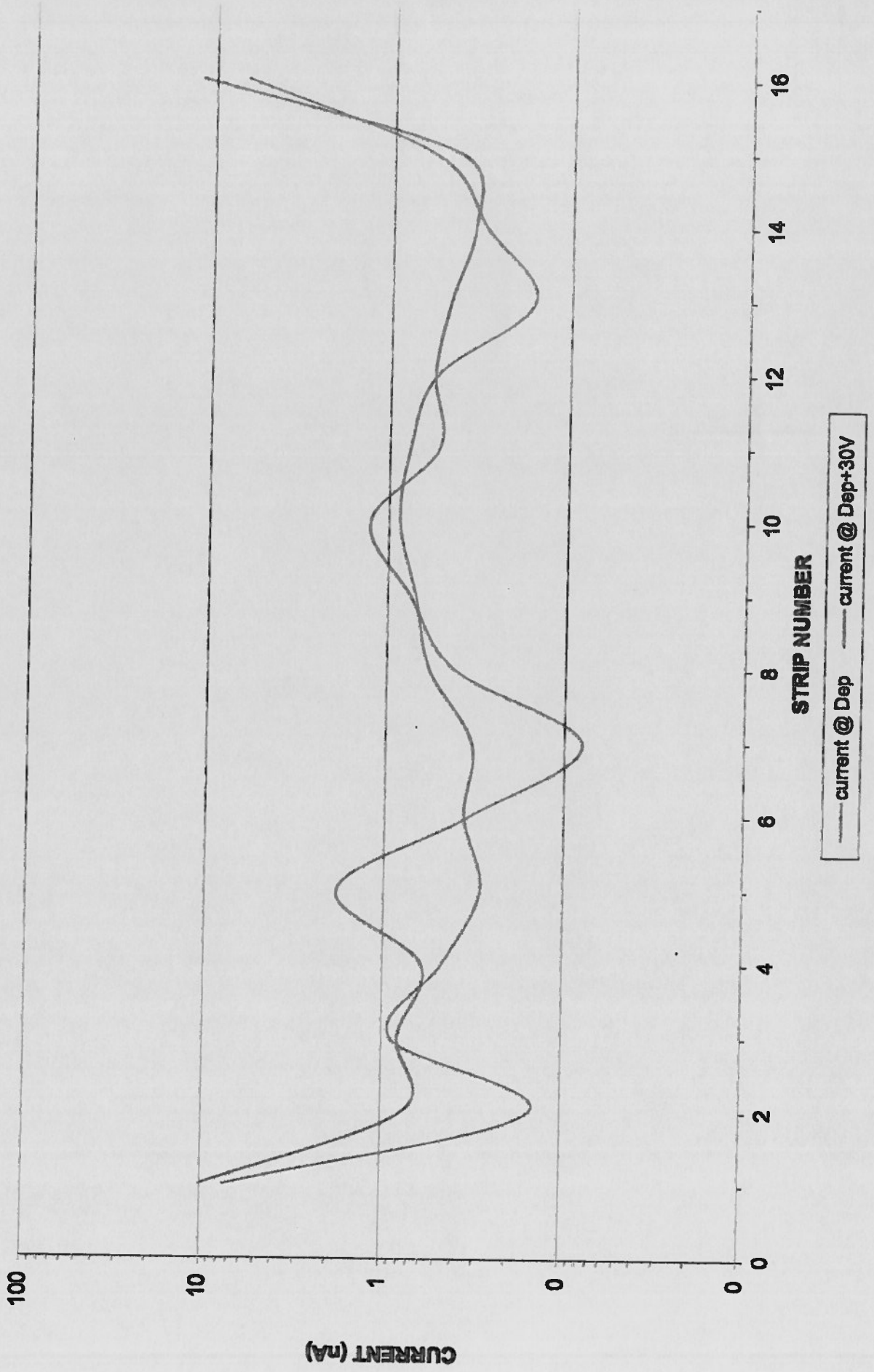
W1-500

Wafer No.: **3288-21**

Thickness: **530**  $\mu\text{m}$   
Depletion: **50** Volts

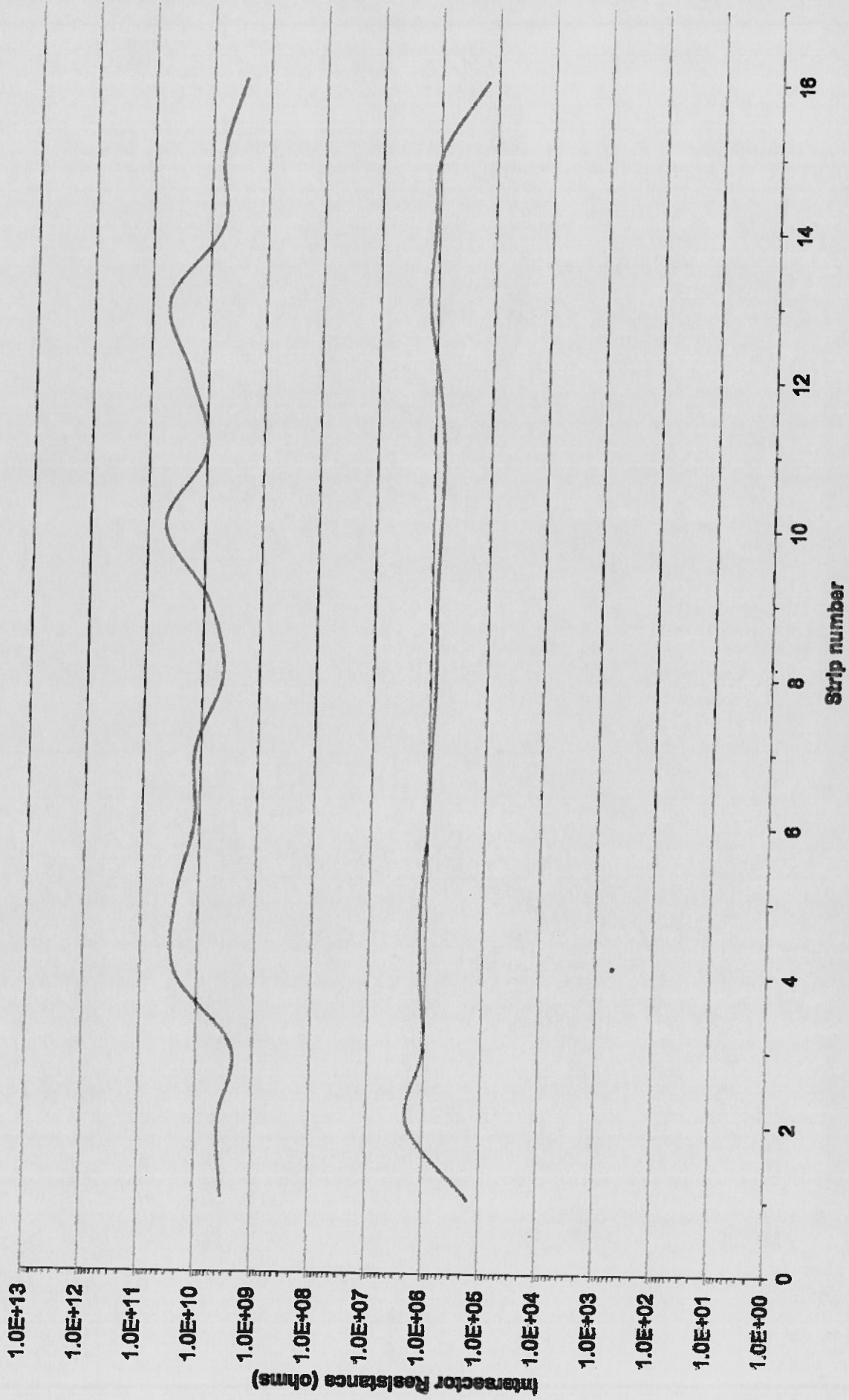


Design-W1\_500 D/S  
3288-21 Ohmic side Dep=50V



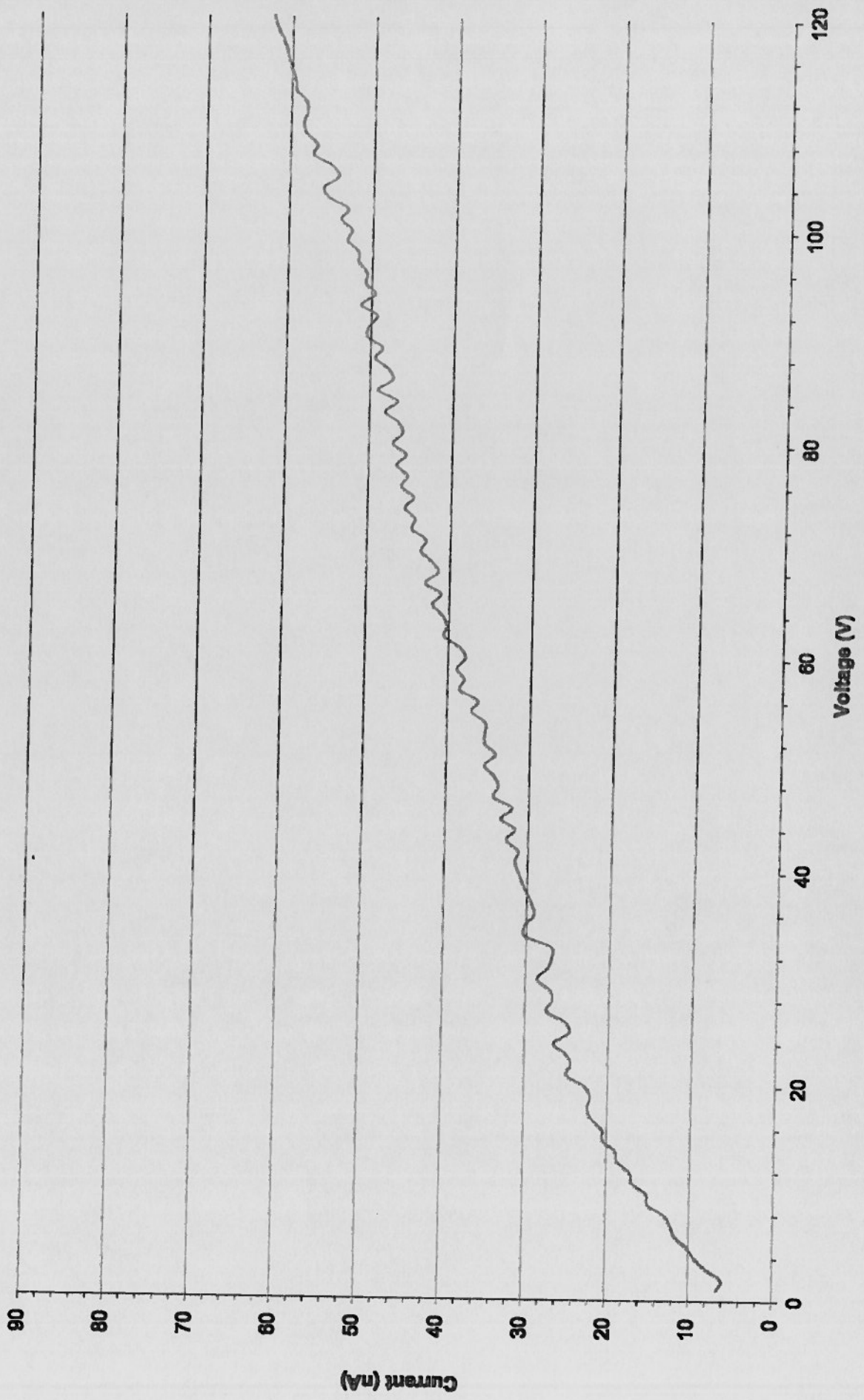


Design-W1\_500 D/S  
3288-21 Ohmic side Dep=50V

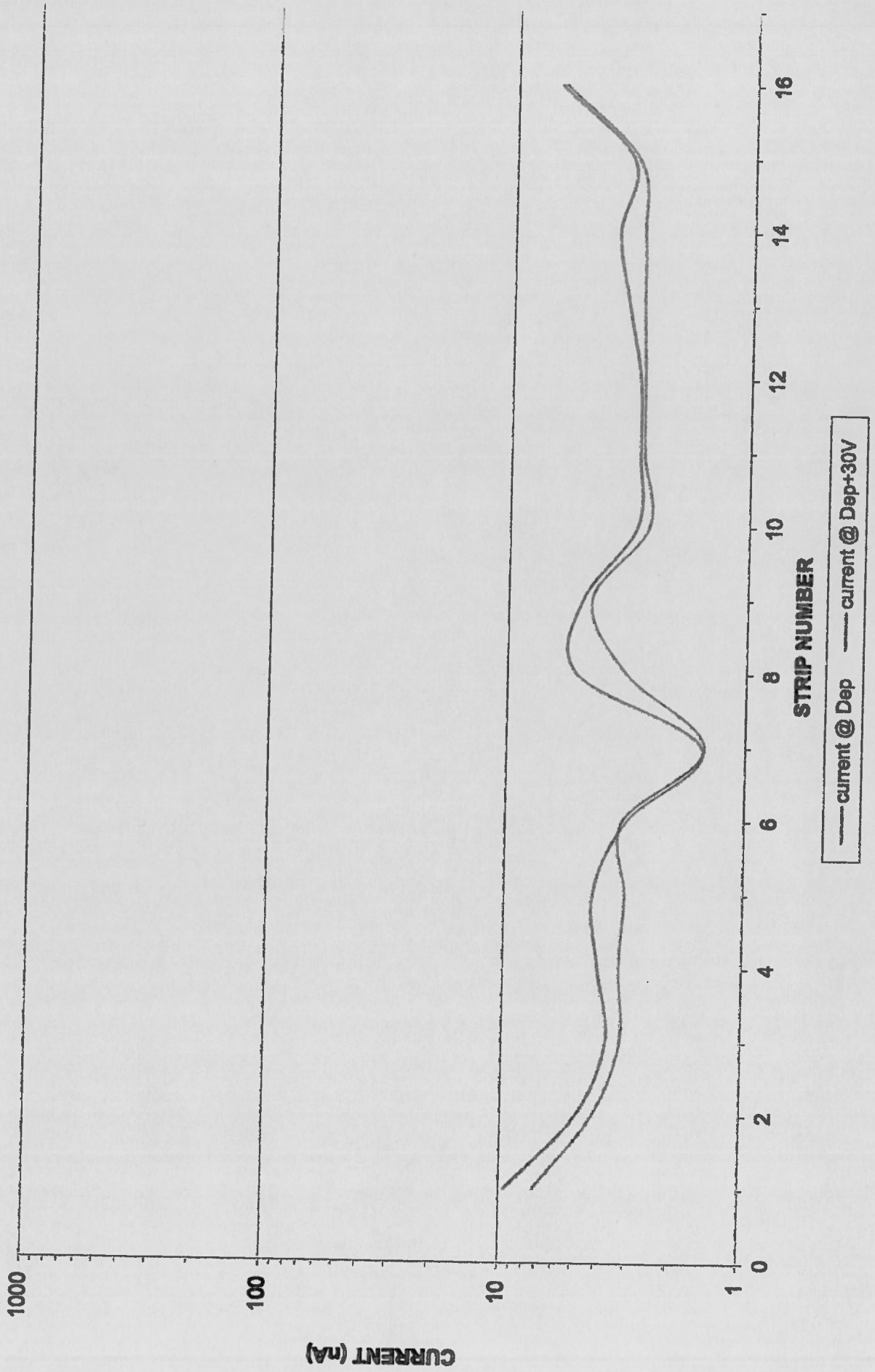


Inter @ Dep Inter @ Dep+90V

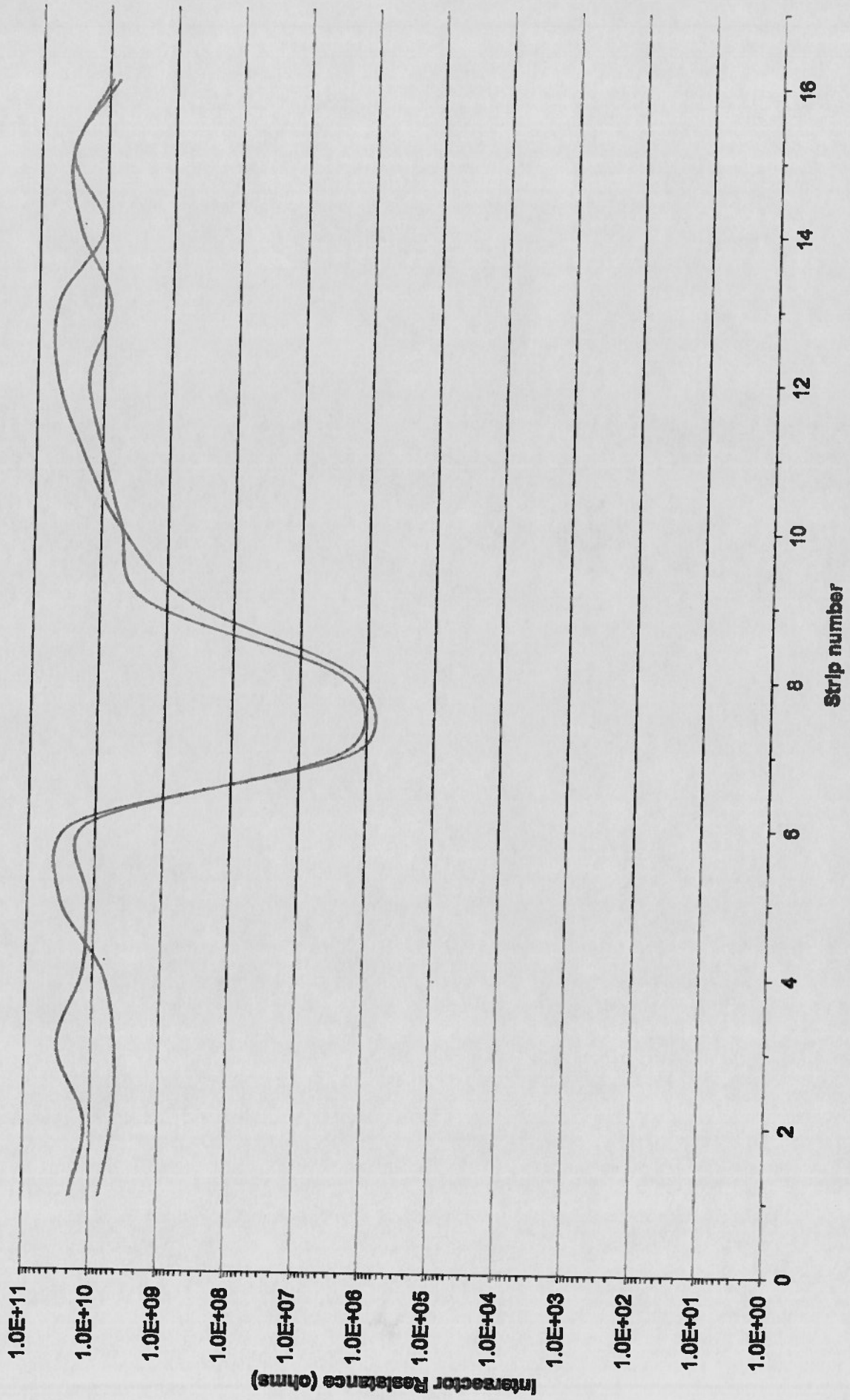
Design-W1\_500 D/S  
3288-21 TOTAL DETECTOR IV  
Dep=50V Thickness=530um



Design-W1\_500 D/S  
3288-21 Junction side Dep=50V



Design-W1\_500 D/S  
3288-21 Junction side Dep=50V

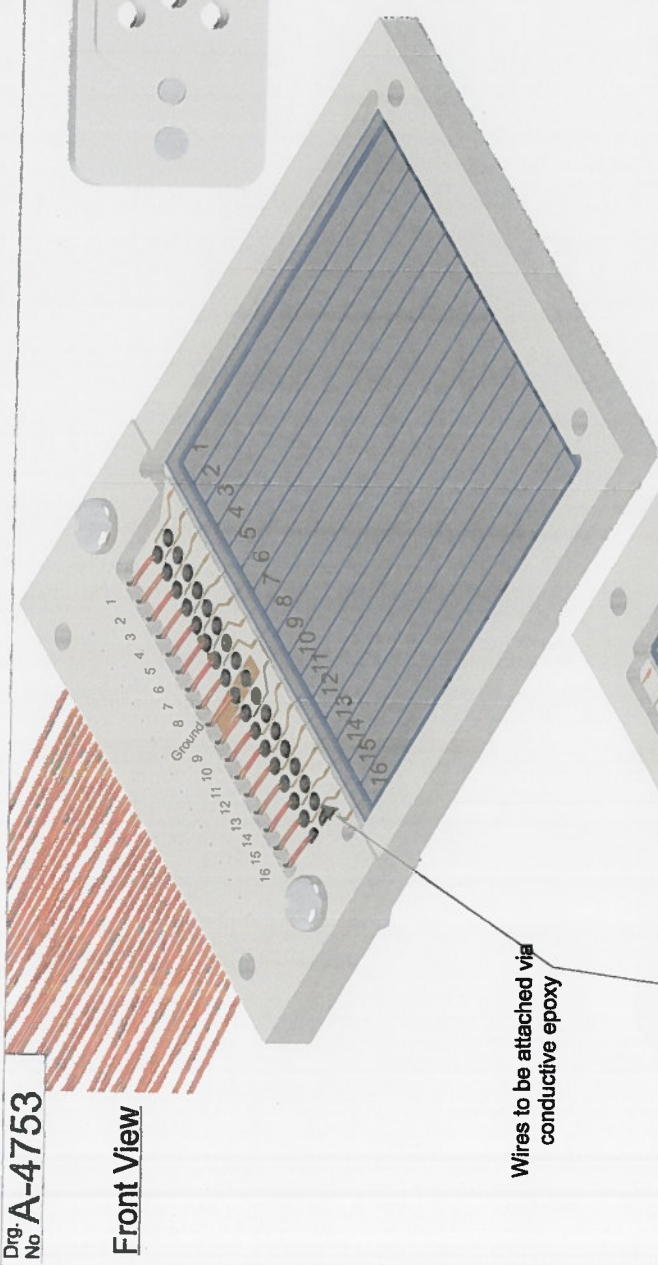


— Inter @ Dep    - - - Inter @ Dep+30V



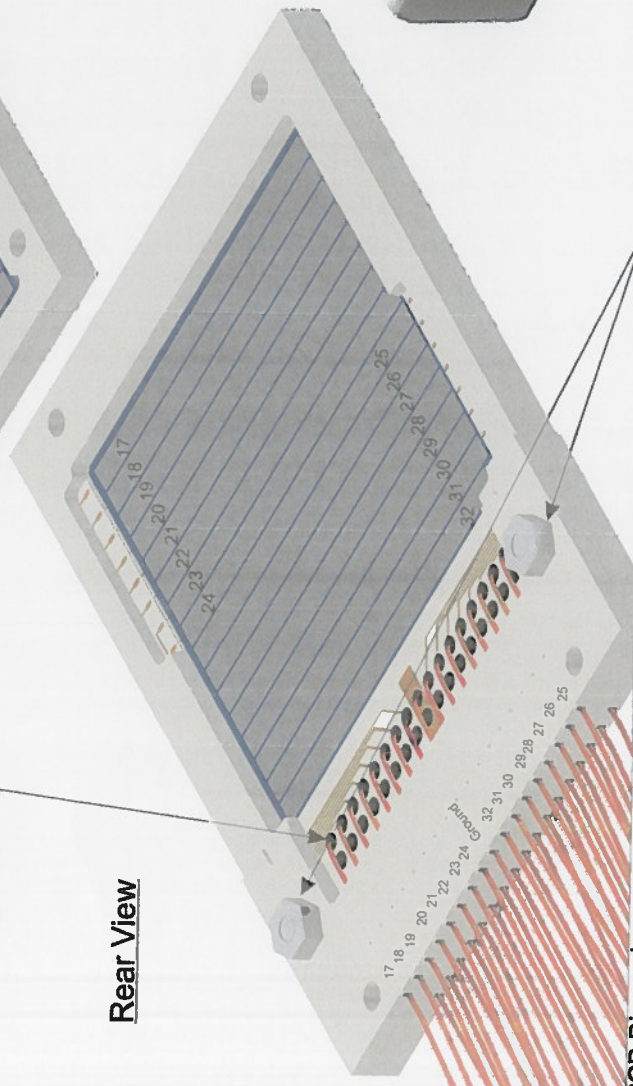
Drwg. No. **A-4753**

**Front View**



Wires to be attached via conductive epoxy

**Rear View**

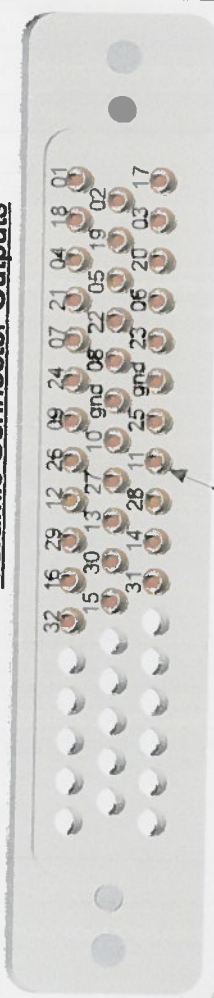


2 x Stainless steel screws and nuts  
no thread showing past the nut

**PCB Dimensions** = 63.50 x 86.50 x 4.90 mm<sup>3</sup>  
**Chip Dimensions** = 53.78 x 53.78 mm<sup>2</sup>  
**Active Area** = 49.50 x 49.50 mm<sup>2</sup>

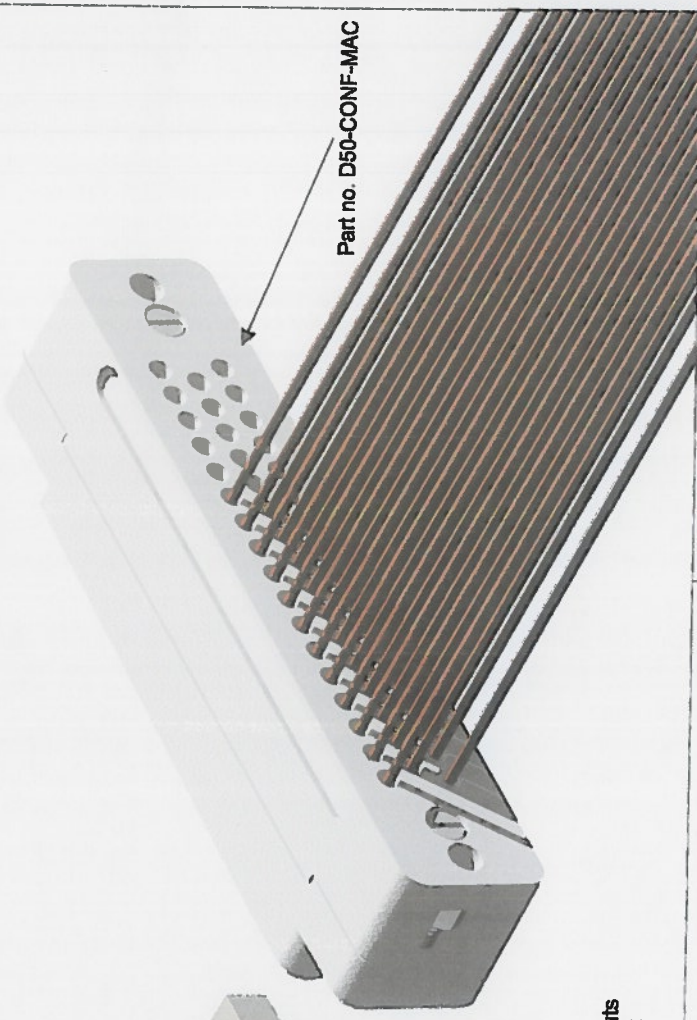
Drawn	Checked	Date	Title	
N.W	S.W	05/10/2017	Design W type 2M/2M. On 2017 Design Rogers PCB 3D Assembly.	
Des	Outputs: 32 x 1.0 mm long Keyflex Wire, L=the Pin no. 100V-V7X006 Inp. Part no. D50-CONF-124C			
Appd	Mating connector:			
Customer	Testing Mating connector: N/A			
			Substrate Number: A-4723 and A-4724	
			Potted Wire Bonds: No	
			Substrate Material: Rogers 4350	
			Connector Orientation: Straight connector at end of cables.	
			Material Thickness ± 10%	

**Ceramic Connector Outputs**



Connector outputs to be crimped using crimps part no. DPINF-25 and crimp tool Part no. DCT1

**Ceramic Connector**



Part no. D50-CONF-MAC

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graphics@micronsemiconductor.co.uk

Scale N/A    Dims In. mm    Drg No A-4753